

HFM101-M THRU HFM107-M

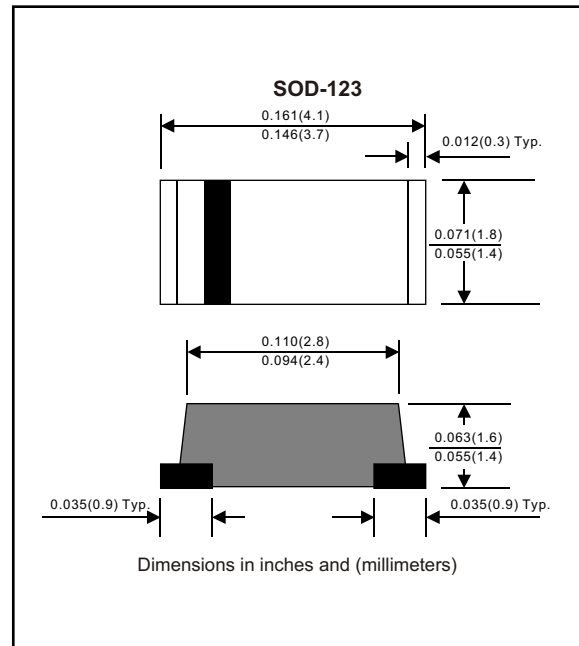
Ultra fast recovery type

Features

- Plastic package has Underwriters Laboratory Flammability Classification 94V-O Utilizing Flame Retardant Epoxy Molding Compound.
- For surface mounted applications.
- Exceeds environmental standards of MIL-S-19500 / 228
- Low leakage current

Mechanical data

Case : Molded plastic, JEDEC SOD-123 / MINISMA
 Terminals : Solder plated, solderable per MIL-STD-750, Method 2026
 Polarity : Indicated by cathode band
 Mounting Position : Any
 Weight : 0.04 gram



MAXIMUM RATINGS (AT T_A=25°C unless otherwise noted)

PARAMETER	CONDITIONS	Symbol	MIN.	TYP.	MAX.	UNIT
Forward rectified current	Ambient temperature = 50°C	I _O			1.0	A
Forward surge current	8.3ms single half sine-wave superimposed on rate load (JEDEC methode)	I _{FSM}			30	A
Reverse current	V _R = V _{RRM} T _A = 25°C	I _R			5.0	uA
	V _R = V _{RRM} T _A = 100°C				150	uA
Thermal resistance	Junction to ambient	R _{QJA}		42		°C / w
Diode junction capacitance	f=1MHz and applied 4vDC reverse voltage	C _J		20		pF
Storage temperature		T _{STG}	-55		+150	°C

SYMBOLS	MARKING CODE	V _{RRM} *1 (V)	V _{RMS} *2 (V)	V _R *3 (V)	V _F *4 (V)	T _{RR} *5 (nS)	Operating temperature (°C)
HFM101-M	H1	50	35	50	1.0	50	-55 to +150
HFM102-M	H2	100	70	100			
HFM103-M	H3	200	140	200			
HFM104-M	H4	300	210	300	1.3	75	
HFM105-M	H5	400	280	400			
HFM106-M	H6	600	420	600	1.7	75	
HFM107-M	H7	800	560	800			

- *1 Repetitive peak reverse voltage
- *2 RMS voltage
- *3 Continuous reverse voltage
- *4 Maximum forward voltage
- *5 Reverse recovery time

RATING AND CHARACTERISTIC CURVES (HFM101-M THRU HFM107-M)

FIG.1-TYPICAL FORWARD CHARACTERISTICS

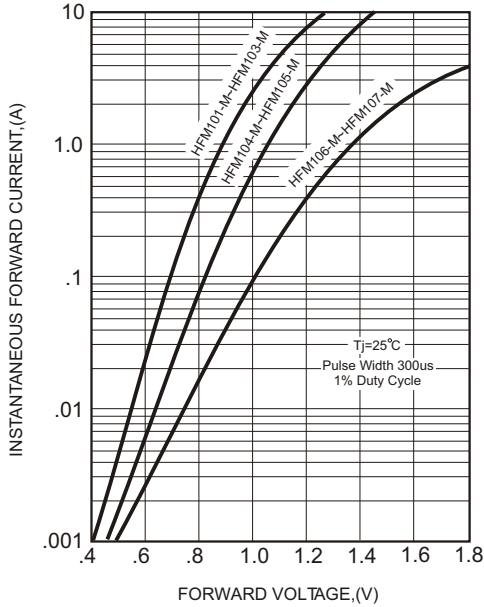


FIG.2-TYPICAL FORWARD CURRENT DERATING CURVE

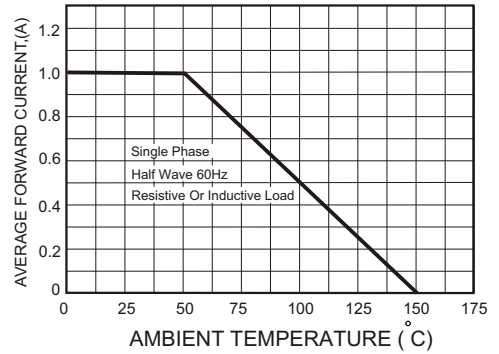


FIG.4-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

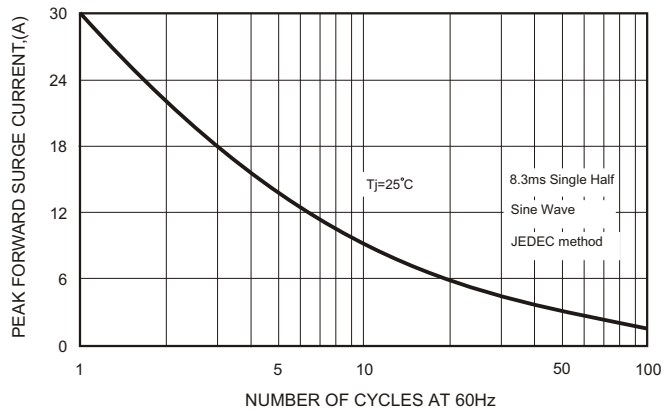
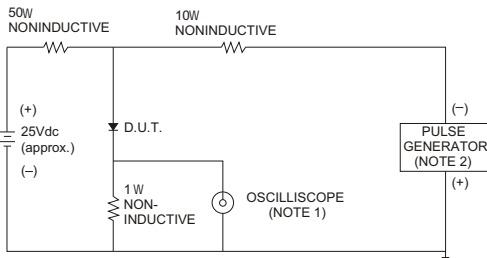


FIG.3- TEST CIRCUIT DIAGRAM AND REVERSE RECOVERY TIME CHARACTERISTICS



- NOTES: 1. Rise Time= 7ns max., Input Impedance= 1 megohm, 22pF.
2. Rise Time= 10ns max., Source Impedance= 50 ohms.

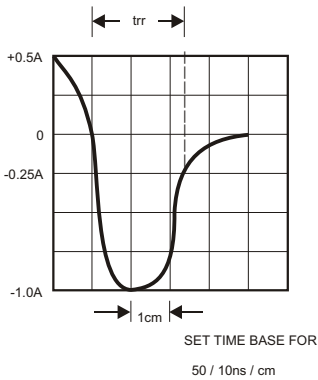


FIG.5-TYPICAL JUNCTION CAPACITANCE

